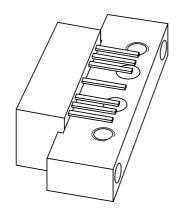
DISCRETE SEMICONDUCTORS

DATA SHEET



BGD702N 750 MHz, 18.5 dB gain power doubler amplifier

Product specification Supersedes data of 2001 Oct 25 2001 Nov 02





750 MHz, 18.5 dB gain power doubler amplifier

BGD702N

FEATURES

- · Excellent linearity
- · Extremely low noise
- Silicon nitride passivation
- · Rugged construction
- Gold metallization ensures excellent reliability.

APPLICATIONS

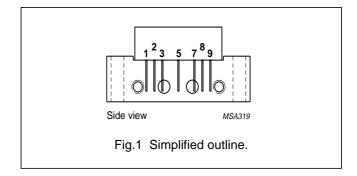
 CATV systems operating in the 40 to 750 MHz frequency range.

DESCRIPTION

Hybrid amplifier module in a SOT115J package operating at a voltage supply of 24 V (DC).

PINNING - SOT115J

PIN	DESCRIPTION
1	input
2	common
3	common
5	+V _B
7	common
8	common
9	output



QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
Gp	power gain	f = 50 MHz	18	19	dB
		f = 750 MHz	18.5	_	dB
I _{tot}	total current consumption (DC)	V _B = 24 V	_	435	mA

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER		MAX.	UNIT
Vi	RF input voltage	_	65	dBmV
T _{stg}	storage temperature	-40	+100	°C
T _{mb}	operating mounting base temperature	-20	+100	°C

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CHARACTERISTICS

Table 1 Bandwidth 40 to 750 MHz; $V_B = 24 \text{ V}$; $T_{mb} = 35 \,^{\circ}\text{C}$; $Z_S = Z_L = 75 \,\Omega$

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
Gp	power gain	f = 50 MHz	18	19	dB
		f = 750 MHz	18.5	_	dB
SL	slope cable equivalent	f = 40 to 750 MHz	0.2	2	dB
FL	flatness of frequency response	f = 40 to 750 MHz	_	±0.25	dB
S ₁₁	input return losses	f = 40 to 80 MHz	20	_	dB
		f = 80 to 160 MHz	19	_	dB
		f = 160 to 320 MHz	18	_	dB
		f = 320 to 640 MHz	17	_	dB
		f = 640 to 750 MHz	16	_	dB
S ₂₂	output return losses	f = 40 to 80 MHz	20	_	dB
		f = 80 to 160 MHz	19	_	dB
		f = 160 to 320 MHz	18	_	dB
		f = 320 to 640 MHz	17	_	dB
		f = 640 to 750 MHz	16	_	dB
S ₂₁	phase response	f = 50 MHz	-45	+45	deg
СТВ	composite triple beat	110 channels flat; V _o = 44 dBmV; measured at 745.25 MHz	_	-58	dB
X _{mod}	cross modulation	110 channels flat; V _o = 44 dBmV; measured at 55.25 MHz	_	-62	dB
CSO	composite second order distortion	110 channels flat; V _o = 44 dBmV; measured at 746.5 MHz	-	-58	dB
d_2	second order distortion	note 1	_	-68	dB
Vo	output voltage	$d_{im} = -60 \text{ dB}$; note 2	61	_	dBmV
F	noise figure	f = 50 MHz	_	5.5	dB
		f = 450 MHz	_	6.5	dB
		f = 550 MHz	_	6.5	dB
		f = 600 MHz	_	7	dB
		f = 750 MHz	_	8.5	dB
I _{tot}	total current consumption (DC)	note 3	_	435	mA

Notes

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1. f_p = 55.25 MHz; V_p = 44 dBmV; f_q = 691.25 MHz; V_q = 44 dBmV; measured at f_p + f_q = 746.5 MHz.
```

2. Measured according to DIN45004B:

$$\begin{split} f_p &= 740.25 \text{ MHz; } V_p = V_o; \\ f_q &= 747.25 \text{ MHz; } V_q = V_o - 6 \text{ dB;} \\ f_r &= 749.25 \text{ MHz; } V_r = V_o - 6 \text{ dB;} \\ \text{measured at } f_p + f_q - f_r = 738.25 \text{ MHz.} \end{split}$$

3. The module normally operates at V_B = 24 V, but is able to withstand supply transients up to 30 V.

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Table 2 Bandwidth 40 to 600 MHz; $V_B = 24$ V; $T_{mb} = 35$ °C; $Z_S = Z_L = 75$ Ω

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
G _p	power gain	f = 50 MHz	18	19	dB
		f = 600 MHz	18.5	_	dB
SL	slope cable equivalent	f = 40 to 600 MHz	0.2	2	dB
FL	flatness of frequency response	f = 40 to 600 MHz	-	±0.2	dB
S ₁₁	input return losses	f = 40 to 80 MHz	20	_	dB
		f = 80 to 160 MHz	19	_	dB
		f = 160 to 320 MHz	18	_	dB
		f = 320 to 600 MHz	17	_	dB
S ₂₂	output return losses	f = 40 to 80 MHz	20	_	dB
		f = 80 to 160 MHz	19	_	dB
		f = 160 to 320 MHz	18	_	dB
		f = 320 to 600 MHz	17	_	dB
S ₂₁	phase response	f = 50 MHz	-45	+45	deg
СТВ	composite triple beat	85 channels flat; V _o = 44 dBmV; measured at 595.25 MHz	-	-65	dB
X _{mod}	cross modulation	85 channels flat; V _o = 44 dBmV; measured at 55.25 MHz	-	-65	dB
CSO	composite second order distortion	85 channels flat; $V_0 = 44 \text{ dBmV}$; measured at 596.5 MHz	_	-60	dB
d ₂	second order distortion	note 1	_	-70	dB
Vo	output voltage	d _{im} = -60 dB; note 2	64	_	dBmV
F	noise figure	see Table 1	_	_	dB
I _{tot}	total current consumption (DC)	note 3	_	435	mA

Notes

```
1. f_p = 55.25 MHz; V_p = 44 dBmV; f_q = 541.25 MHz; V_q = 44 dBmV; measured at f_p + f_q = 596.5 MHz.
```

2. Measured according to DIN45004B:

```
\begin{split} f_p &= 590.25 \text{ MHz; } V_p = V_o; \\ f_q &= 597.25 \text{ MHz; } V_q = V_o - 6 \text{ dB;} \\ f_r &= 599.25 \text{ MHz; } V_r = V_o - 6 \text{ dB;} \\ \text{measured at } f_p + f_q - f_r = 588.25 \text{ MHz.} \end{split}
```

3. The module normally operates at $V_B = 24 \text{ V}$, but is able to withstand supply transients up to 30 V.

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Table 3 Bandwidth 40 to 550 MHz; $V_B = 24$ V; $T_{mb} = 35$ °C; $Z_S = Z_L = 75$ Ω

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
G _p	power gain	f = 50 MHz	18	19	dB
		f = 550 MHz	18.5	_	dB
SL	slope cable equivalent	f = 40 to 550 MHz	0.2	2	dB
FL	flatness of frequency response	f = 40 to 550 MHz	-	±0.2	dB
S ₁₁	input return losses	f = 40 to 80 MHz	20	_	dB
		f = 80 to 160 MHz	19	_	dB
		f = 160 to 320 MHz	18	_	dB
		f = 320 to 550 MHz	17	_	dB
S ₂₂	output return losses	f = 40 to 80 MHz	20	_	dB
		f = 80 to 160 MHz	19	_	dB
		f = 160 to 320 MHz	18	_	dB
		f = 320 to 550 MHz	17	_	dB
S ₂₁	phase response	f = 50 MHz	-45	+45	deg
СТВ	composite triple beat	77 channels flat; V _o = 44 dBmV; measured at 547.25 MHz	-	-67	dB
X _{mod}	cross modulation	77 channels flat; V _o = 44 dBmV; measured at 55.25 MHz	-	-67	dB
CSO	composite second order distortion	77 channels flat; V _o = 44 dBmV; measured at 548.5 MHz	-	-62	dB
d ₂	second order distortion	note 1	_	-72	dB
Vo	output voltage	$d_{im} = -60 \text{ dB}$; note 2	64.5	_	dBmV
F	noise figure	see Table 1	-	_	dB
I _{tot}	total current consumption (DC)	note 3	_	435	mA

Notes

```
1. f_p = 55.25 MHz; V_p = 44 dBmV; f_q = 493.25 MHz; V_q = 44 dBmV; measured at f_p + f_q = 548.5 MHz.
```

2. Measured according to DIN45004B:

```
\begin{split} f_p &= 540.25 \text{ MHz; } V_p = V_o; \\ f_q &= 547.25 \text{ MHz; } V_q = V_o - 6 \text{ dB;} \\ f_r &= 549.25 \text{ MHz; } V_r = V_o - 6 \text{ dB;} \\ \text{measured at } f_p + f_q - f_r = 538.25 \text{ MHz.} \end{split}
```

3. The module normally operates at $V_B = 24 \text{ V}$, but is able to withstand supply transients up to 30 V.

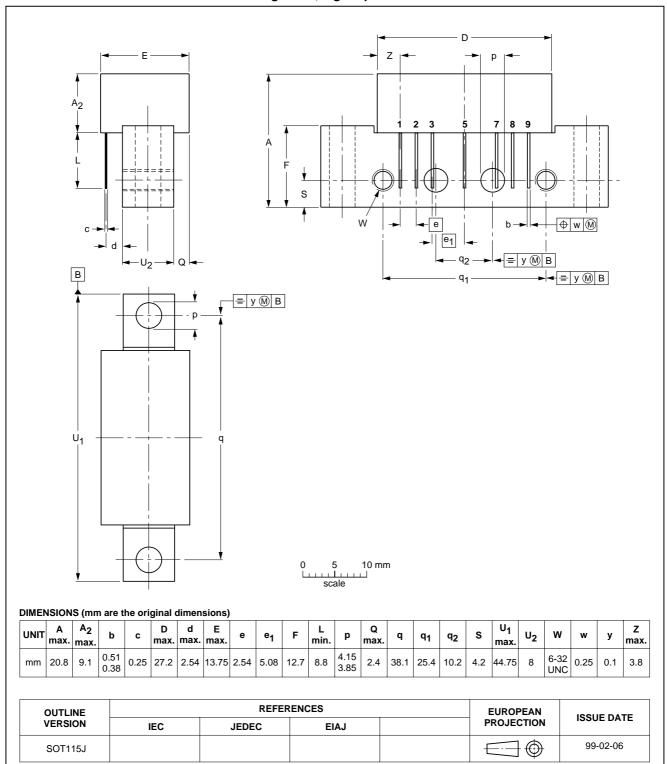
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PACKAGE OUTLINE

Rectangular single-ended package; aluminium flange; 2 vertical mounting holes; 2 x 6-32 UNC and 2 extra horizontal mounting holes; 7 gold-plated in-line leads

SOT115J



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DATA SHEET STATUS

DATA SHEET STATUS(1)	PRODUCT STATUS ⁽²⁾	DEFINITIONS
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